# **BGA Heat Sink - High Performance** maxiFLOW/superGRIP



#### ATS Part#:

Description:



Heat Sink Type:

ATS-X50310B-C1-R0

31.00 x 31.00 x 7.50 mm BGA Heat Sink - High Performance maxiFLOW/superGRIP

maxiFLOW

Heat Sink Attachment: Equivalent Part Number: N/A

superGRIP

\*Image above is for illustration purpose only.

### **Features & Benefits**

- Designed for 31 x 31 mm components •
- Requires minimal space around the component's perimeter; ideal for densely populated PCBs •
- Allows the heat sink to be detached and reattached without damaging the component or the PCB, an important feature in the event a • PCB may need to be reworked
- Strong, uniform attachment force helps achieve maximum performance from phase-changing TIMs
- Eliminates the need to drill mounting holes in the PCB .

## **Thermal Performance**

		@200 LFM 1.0 M/S	@300 LFM 1.5 M/S	@400 LFM 2.0 M/S	@500 LFM 2.5 M/S	@600 LFM 3.0 M/S	@700 LFM 3.5 M/S	@800 LFM 4.0 M/S
THERMAL RESISTANCE	Unducted Flow	6.9 °C/W	5.5 °C/W	4.7 °C/W	4.2 °C/W	3.9 °C/W	3.6 °C/W	3.3 °C/W
	Ducted Flow	5.3	N/A	N/A	N/A	N/A	N/A	N/A

## **Product Detail**

Schematic Image	Dimension A	Dimension B	Dimension C	Dimension D	ТІМ	Finish
	31.00 mm	31.00 mm	7.50 mm	44.4 mm	T766	BLUE-ANODIZED
There above is for illustration purpose only.	<ul> <li>Dimension</li> <li>Thermal papplication</li> <li>ATS resense performant</li> <li>ATS certification</li> </ul>	performance data are n. rves the right to upda nce. ies that this heat sin	emponent size. neight from the bottor e provided for referen ate or change its pro- k assembly is RoHS istom options availat	nce only. Actual perfo ducts without notice -6 and REACH com	ormance to improv	may vary by

For more information, to find a distributor or to place an order, please contact us at 781-769-2800 (North America), sales@qats.com or www.qats.com.

